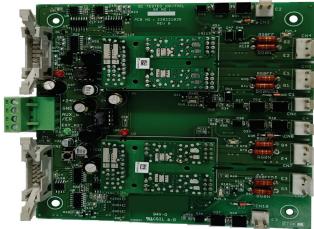
RAM ENTERPRISE



THE POWER SOLUTIONS

H BRIDGE MINI MASTER

PARALLEL / H BRIDGE CONFIGURATION PART CODE : 220221035

Excellent Plug & Play solution!!

Features

- ▶ 4X1.2 Watt Compact Four channel driver ▶ Parallel / Full bridge drive configuration
- Switching frequency up to 20 KHz
- ±15A gate current, +15V/-6V
- **Prive up to 1200V IGBT Module**
- ➤ 10-PIN & MSTB-4PIN Electrical Interface ➤ Superior EMI-EMC
- **Extremely reliable & rugged design**
- Integrated short-circuit soft shutdown
- In-build Dead band generation

- - **>** Less than 500 nS delay time
 - Less aging effect due to ASIC
 - Primary/Sec. under voltage lockout
 - > Vce monitoring for short circuit current

 - **F** IGBT mount Plug & Play solution
 - Advance active clamping for over voltage protection
 - +24 Or +15 Volt power supply(Optional)Factory set

Benefits

- On board isolated DC-DC converter No need of separate SMPS.
- Interface for 13.0V...15 V logic level Direct compatible with any Controller.
- **>** Single Fault feedback signal to interface with controller.
- Field configurable blocking time Flexibility in your hand, use any make IGBT !!
- Safe isolation to IEC 61800-5-1, IEC-60664-1 & En50178, protection class II
- User selectable Rg(on) & Rg(off)

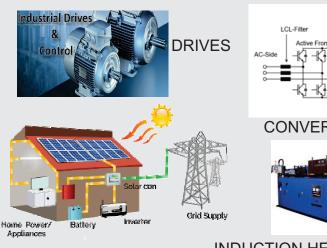
Application



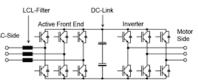
WIND TURBINE



RAILWAY CONVERTER



SOLAR INVERTER



CONVERTER - INVERTER



INDUCTION HEATING & MELTING

"Drive the IGBT with experience hand"

WEB: www.ramenterprise.co.in



Technical Specification

Recommended Operating condition

Power Supply & Monitoring MIN TYP MAX
1. Supply Voltage Vcc to GND : 18 24 26 V
2. Supply Current Icc (Without Load): 50mA (@20KHz PWM I/P)
3. Under Voltage Primary, Set Fault : 11.3 12.1 12.7 V
Clear Fault : 11.9 12.8 13.3 V
Secondary, Set Fault : 11.5 12.0 12.5 V
Clear Fault : 12.1 12.6 13.1 V

Logical Inputs & Outputs

1. Input Bias Current	: 190 µA
2. Interface Logic level	: 13.0 V 15.0 V logic level
3. Turn-on threshold	: 12 V (typ)
4. Turn off threshold	: 10.7 V (typ)
5. SOx output , failure Condition	: 0.7 V Max., I (SOx) < 20mA total

Short-Circuit Protection

- 1. Vce-monitoring threshold
- 2. Response(blanking) time : 4.5µSec (R52,R71,R112,R116:18KΩ)
- 3. Minimum response time
- 4. Available blocking time (R4)
- 5. Minimum blocking time (R4)

: 1.2 µSec : 49 mSec (100K) Factory Set : 9 µSec(0E)

Factory Set

: Diode sense method

: 9.3 V (Internally Fix)

Timing Characteristic (Input to Output of Driver board under No-Load) :400 nS, Max.

1. Turn-on delay t_{d(on)} 2. Turn-off delay t_{d(off)} 3. Time synchronization for

:75 nS, Max.

parallel IGBT drive For detail timing information of driver core, refer part specific datasheet.

:400 nS, Max.

Protection Available on driver board

- 1. Primary/Secondary Under voltage monitoring & error feedback.
- 2. Power supply reverse polarity.
- 3. Advance active clamping, For IGBT Over Voltage.
- 4. Vce monitoring for short circuit current.
- 5. Schmitt trigger at the Input stage, highly immune to noise.
- 6. Interfacing with user's control circuit via EXTRESET pin so fault latching possible.(Optional)

Electrical Isolation

Test voltage (50 Hz/1 sec)	
1. Primary to secondary side	:4.0
2 Casandan ita sasandan isida	. 1 0

2. Secondary to secondary side :4.0 KV

This gate driver is suited for HiPot testing. Nevertheless, it is strongly recommended to limit the testing time to 1s slots. Excessive HiPot testing at voltages much higher than $850V_{\scriptscriptstyle AC(eff)}$ may lead to insulation degradation. No degradation has been observed over 1 min. testing at 4000V_{AC(eff)}Each driver core production sample shipped has undergone 100% testing at the given value or higher for 1s.

ΚV

Output Voltage / Current / Power

output voltage, current, i one	•			
1. Turn-on voltage, V _{GHx}	: 15.0 V, any load condition			
2. Turn-off voltage, V _{GLx}	: -8.5 V, No load			
3. Turn-off voltage, V _{GLx}	:-6.6 V@1W			
4. Gate Peak Current I _{out}	: ±15 Amp			
5. External Gate resistance	: 2.5 Ω, Minimum for more than 25 Khz			
	: 1.0 Ω,Minimum for Less than 25 Khz			
6. Switching frequency F	: 50 Khz			
7. Output Power	: 0.4 W, T <105 °C			
	: 1.0 W, T <85 °C			
	: 1.2W, T <70 °C			
	: 1.4 W, T <55°C			
Part used on Plug & play driver	: 2SC0115T2A0-12 from Power Integration			
	(02 Qty/Board)			
(for more detail, kindly check part specific datasheet from PI)				

Environmental

Working temperature Storage temperature

: -20 to 105°C : -40 to 105 °C

THE POWER SOLUTIONS

Driving Capability

: INFINEON / SEMIKRON /FUJI The H Bridge MINI MASTER drives all usual 62mm / Prime Pack2 IGBT modules up to 1400A/1200 V. Power depends on switching frequency so in case of any doubt during selection process please contact.

Interfacing with Control Circuit

Electrical

ERROR : High (Normal) to Low (Error) (JP1 SHORT - (1-2)) High (Error) to Low (Normal) (JP1 SHORT - (2-3)) Open collector output (Optional).

EXTRST : 5 μ Sec high to low Pulse/ Do ground if function not used in circuit.

LED Indication

Power ON: Green (Normally ON, Off during Power supply fault) PWM_1, PWM_2, PWM_3, PWM_4: YELLOW LED

ON: PWM Pulse available, OFF : absent) ERROR (ER1, ER2) : RED (Normally off, On during FAULT) (ERROR on individual Output channel)

ORDERING CODE - 220221035

H BRIDGE MINI MASTER	Description
	1.2WX2, 15A, 50KHz 1200V CLASS IGBT DRIVER
	ELECTRICAL Interface
220221035	Default Gate Resistor: 2E Rg(On), 2E Rg(Off)
220221055	Delault Gale Resistor. 22 Rg(OII), 22 Rg(OII)

Interfacing with Control Circuit

INPUT Detai	l 10 Pin FRC	FOR PWM: CN	1/CN2	
1 (CN1)TOP	PWM_A1	1 (CN2)TOP	PWM_A3	
9 (CN1)BOT	PWM_A2	9 (CN2)BOT	PWM_A4	
2,10	GND	2,10	GND	
3,4,5,6,7,8 (CN1/CN2) NC				

2

INPUT Detail 4 Pin MSTB: TB1 (Optional) GND

- 1 +24/+15V
- AUX_5 /ER (ERROR OUTPUT) З
- 4 EXT_RST (IF NOT IN USE - MUST GND)

MECHANICAL DIMENSION:



ALL DIMENSIONS ARE IN MM

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www.ramenterprise.co.in



FRC CABLE